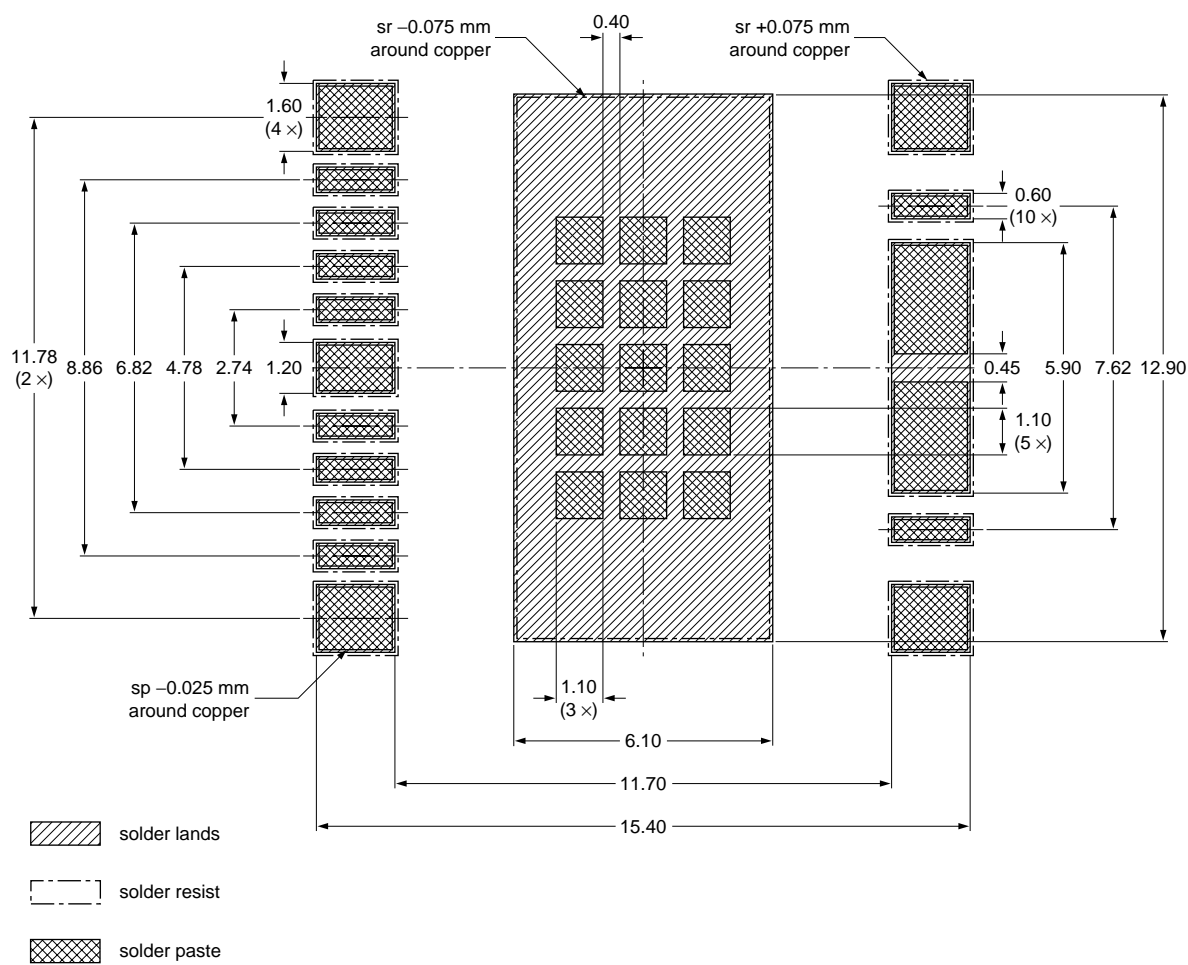


Footprint for reflow soldering of HSOP16 package

SOT822-1



sot822-1\_fr